

10/669,901

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	698	((MEMS) adj device) and ((MEMS) adj structure)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 18:20
L2	2	(semiconductor adj integrated adj circuit) and (thermal adj bond)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 18:21
L3	104	(integrated adj circuit) and (thermal adj bond)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 18:24
L4	398	package and (thermal adj bond)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/19 18:24